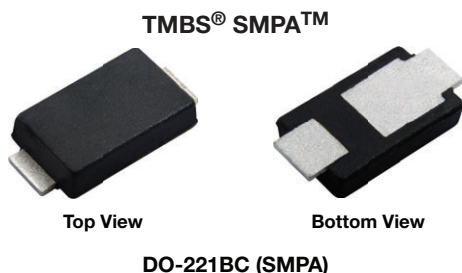


Surface Mount Trench MOS Barrier Schottky Rectifier



FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

PRIMARY CHARACTERISTICS

| | |
|--|-----------------|
| $I_{F(AV)}$ | 3.0 A |
| V_{RRM} | 45 V |
| I_{FSM} | 80 A |
| V_F at $I_F = 3.0$ A ($T_A = 125$ °C) | 0.37 V |
| T_J max. | 150 °C |
| Package | DO-221BC (SMPA) |
| Diode variation | Single die |

MECHANICAL DATA

Case: DO-221BC (SMPA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,.....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

| PARAMETER | SYMBOL | V3PAL45 | UNIT |
|---|----------------------|-------------|------|
| Device marking code | | 3L45 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 45 | V |
| Maximum DC forward current | I_F ⁽¹⁾ | 3.0 | A |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I_{FSM} | 80 | A |
| Operating junction and storage temperature range | T_J, T_{STG} | -40 to +150 | °C |

Note

⁽¹⁾ Free air, mounted on recommended copper pad area

| ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted) | | | | | |
|--|----------------------|-------------|------|------|---------------|
| PARAMETER | TEST CONDITIONS | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | $I_F = 1.5\text{ A}$ | $V_F^{(1)}$ | 0.41 | - | V |
| | $I_F = 3.0\text{ A}$ | | 0.46 | 0.54 | |
| | $I_F = 1.5\text{ A}$ | | 0.30 | - | |
| | $I_F = 3.0\text{ A}$ | | 0.37 | 0.46 | |
| Reverse current | $V_R = 45\text{ V}$ | $I_R^{(2)}$ | - | 450 | μA |
| | | | 5 | 15 | mA |
| Typical junction capacitance | 4.0 V, 1 MHz | C_J | 450 | - | pF |

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width $\leq 5\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise specified) | | | |
|---|-----------------------|---------|----------------------|
| PARAMETER | SYMBOL | V3PAL45 | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)}$ | 100 | $^{\circ}\text{C/W}$ |
| | $R_{\theta JM}^{(1)}$ | 9 | |

Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

| ORDERING INFORMATION (Example) | | | | |
|---------------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V3PAL45-M3/I | 0.032 | I | 14 000 | 13" diameter plastic tape and reel |
| V3PAL45HM3/I ⁽¹⁾ | 0.032 | I | 14 000 | 13" diameter plastic tape and reel |
| V3PAL45HM3_A/I ⁽¹⁾ | 0.032 | I | 14 000 | 13" diameter plastic tape and reel |

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

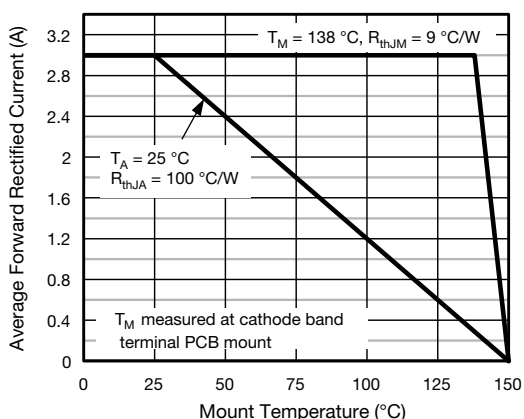


Fig. 1 - Maximum Forward Current Derating Curve

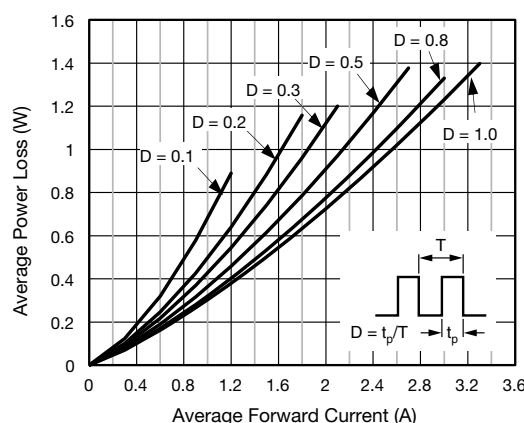


Fig. 2 - Forward Power Loss Characteristics

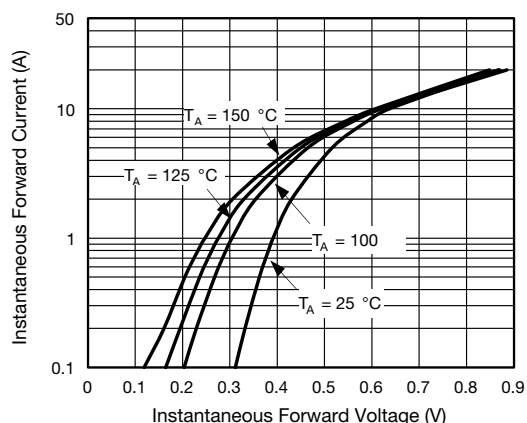


Fig. 3 - Typical Instantaneous Forward Characteristics

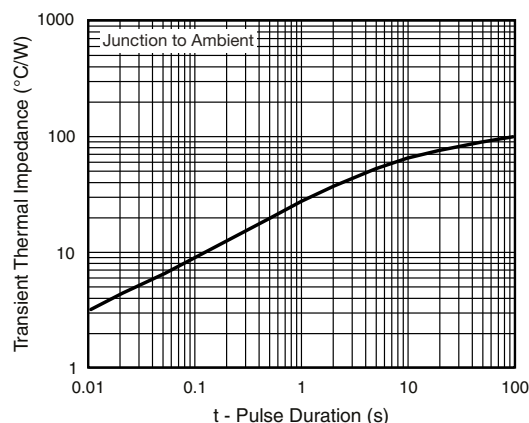


Fig. 6 - Typical Transient Thermal Impedance

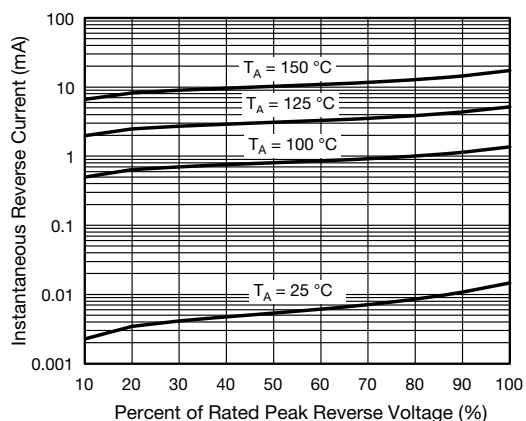


Fig. 4 - Typical Reverse Leakage Characteristics

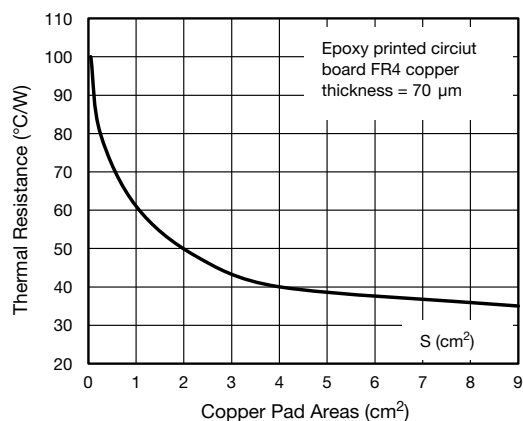


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

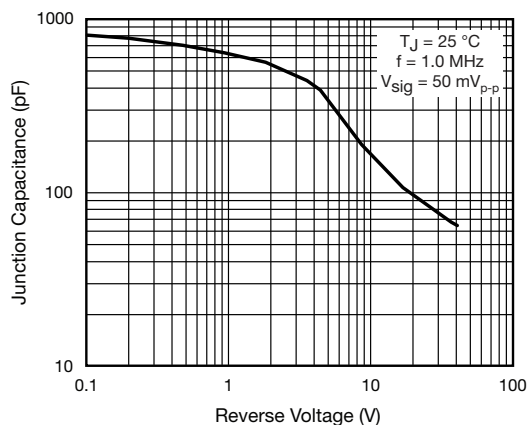
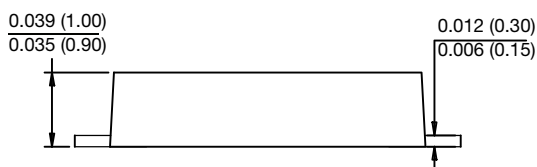
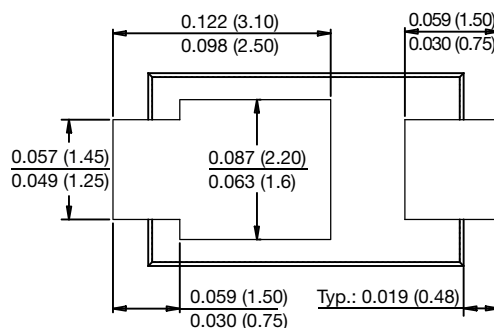
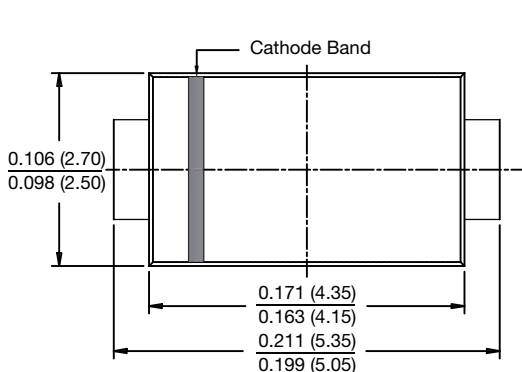


Fig. 5 - Typical Junction Capacitance

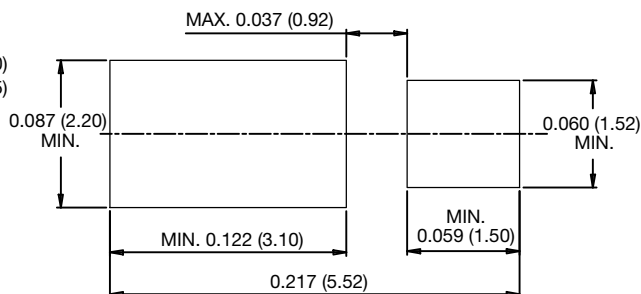


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-221BC (SMPA)



Mounting Pad Layout





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